



# PRODUCT DATASHEET



- ► PCB / CHIP LED
- ▶ 0603 (1608) 0.75t
- True Green 530nm

# N0G42S35ZBF-5MA





# **APPLICATIONS:**

- Keyboard Backlight
- Backlighting
- Indication Light
- Switch light
- Dashboard

# 0603 0.75t Series



# **FEATURES:**

- Package: PCB / CHIP LED Top View
- Forward Current: 5mA
- Forward Voltage (typ.): 2.9V
- Luminous Intensity (typ.): 78mcd@5mA
- Colour: True Green
- Wavelength (typ.): 525~535nm
- Viewing angle: 50°
- Materials:
  - Die: InGaN
  - Resin: Epoxy (Black Housing)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
  - Dominant wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 2a
- Packing: 8mm tape with max.4000/reel, ø180mm (7")

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# **CHARACTERISTICS:**

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	30	mA
Peak Forward Current Duty 1/10; width 0.1ms	IFP	100	mA
Reverse Voltage	V <sub>R</sub>	5	V
Reverse Current @5V	IR	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM)	ESD	6000	V
Operating Temperature	T <sub>OPR</sub>	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

## Electrical & Optical Characteristics (Ta=25°C)

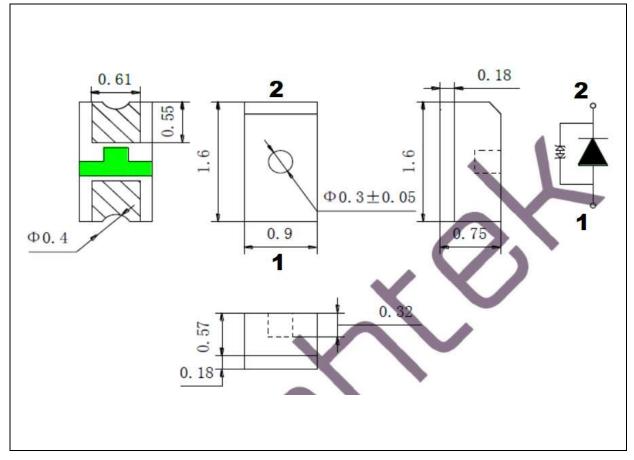
Parameter Symbol		Values			Unit	Test
Parameter	Parameter Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{\text{F}}$	2.5	2.9	3.4	V	I⊧=5mA
Luminous Intensity	lv		78		mcd	I⊧=5mA
Dominant Wavelength	$\lambda_{D}$	525		535	nm	I <sub>F</sub> =5mA
Viewing Angle	<b>2θ</b> <sub>1/2</sub>		50		deg	I⊧=5mA

 $1. \qquad \text{Luminous intensity (I_{V}) \pm 10\%, Forward Voltage (V_{F}) \pm 0.1V, View Angle (2\theta_{1/2}) \pm 5\%, Dominant Wavelength (\lambda_{D}) \pm 1nm.}$ 



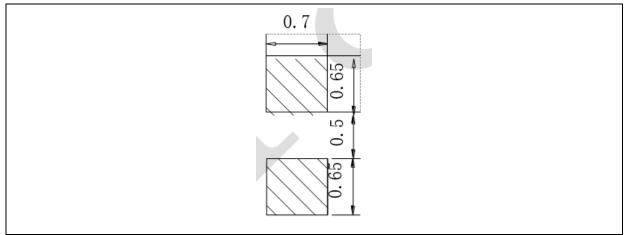
# **OUTLINE DIMENSION:**

## Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

Code	Min.	Max.	Unit
е	2.5	2.8	
f	2.8	3.1	V
g	3.1	3.4	

## Forward Voltage Classifications (I<sub>F</sub> = 5mA):

## Luminous Intensity Classifications (I<sub>F</sub> = 5mA):

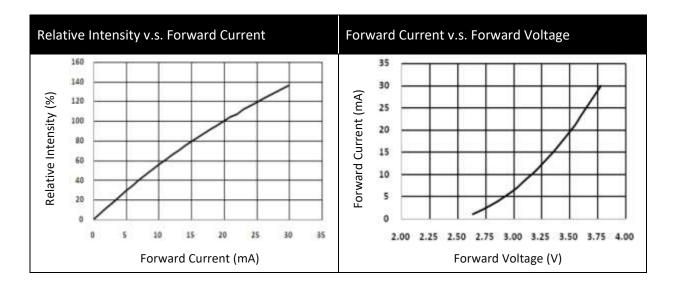
Code	Min.	Max.	Unit
G	50	63	
Н	63	80	us a d
I	80	100	mcd
J	100	125	

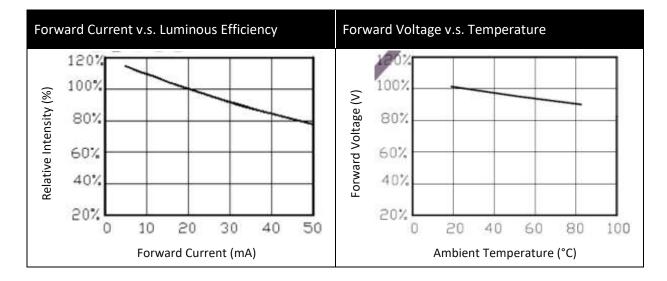
## Dominant Wavelength Classifications (I<sub>F</sub> = 5mA):

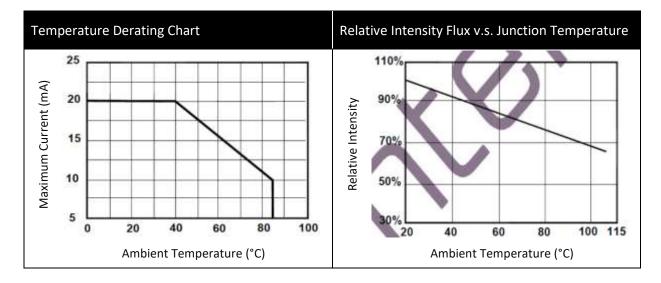
Code	Min.	Max.	Unit
W	525	527.5	
X	527.5	530	2.22
Y	530	532.5	nm
Z	532.5	535	



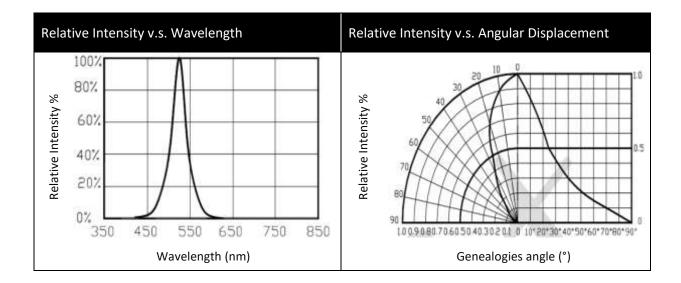
# **ELECTRO-OPTICAL CHARACTERISTICS:**







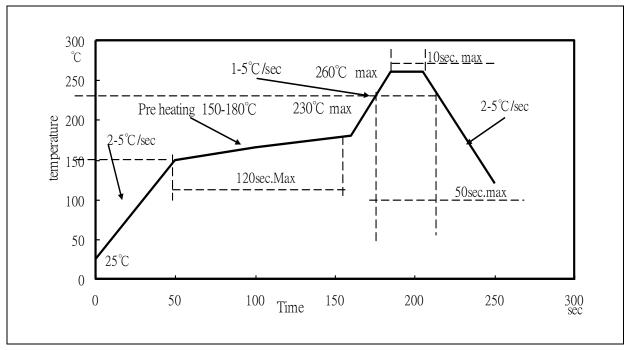




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# **RECOMMENDED SOLDERING PROFILE:**



### Reflow solder:

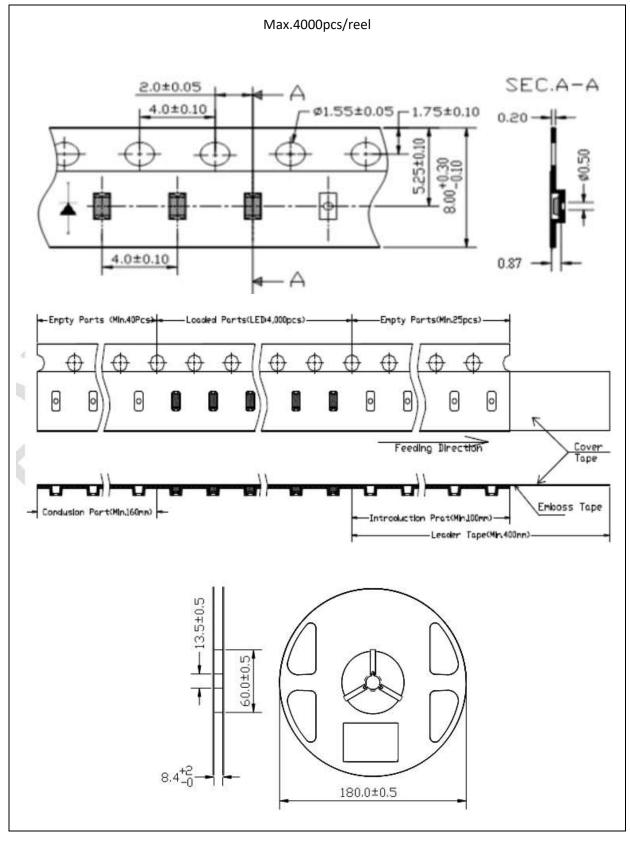
Note:

- 1. Recommend reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maximum reflow soldering: 3 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

### Reel Dimension:



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# **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

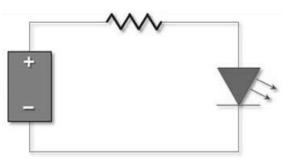
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	23/08/2017	Datasheet set-up.
A1.1	26/05/2022	New datasheet format.